Trench-based Schottky Rectifier, Exceptionally Low Leakage

NRVTS560ETFS, NRVTS560ETFSWF

Features

- Fine Lithography Trench-based Schottky Technology for Very Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- Wettable Flanks (WF in PM Suffix) Option Available for Enhanced Automated Optical Inspection (AoI)
- These are Pb-Free and Halide-Free Devices

Typical Applications

- Switching Power Supplies including Wireless, Smartphone and Notebook Adapters
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing diodes
- Reverse Battery Protection
- Instrumentation
- Automotive LED Lighting

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements
- Mass Approximately 25 mg



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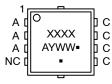
SCHOTTKY BARRIER RECTIFIERS 5 AMPERES 60 VOLTS





WDFN8 (μ8FL) CASE 511AB

MARKING DIAGRAM



XXXX = Specific Device Code

A = Assembly Location Y = Year WW = Work Week

(Note: Microdot may be in either location)

= Pb-Free Package

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 4 of this data sheet.

NRVTS560ETFS, NRVTS560ETFSWF

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 60 | V |
| Average Rectified Forward Current (Rated V _R , T _C = 168°C) | I _{F(AV)} | 5.0 | А |
| Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 167°C) | I _{FRM} | 10 | А |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | 120 | А |
| Storage Temperature Range | T _{stg} | -65 to +175 | °C |
| Operating Junction Temperature | TJ | -55 to +175 | °C |
| Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive) | E _{AS} | 50 | mJ |
| ESD Rating (Human Body Model) | | 3A | |
| ESD Rating (Machine Model) | | M4 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|----------------|-----|------|
| Thermal Resistance, Junction-to-Case, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board) | $R_{	heta JC}$ | 2.6 | °C/W |

ELECTRICAL CHARACTERISTICS

| Characteristic | Symbol | Тур | Max | Unit |
|--|----------------|------|------|------|
| Instantaneous Forward Voltage (Note 1) | v _F | | | V |
| (i _F = 2.5 Amps, T _J = 25°C) | | 0.48 | _ | |
| $(i_F = 5.0 \text{ Amps}, T_J = 25^{\circ}\text{C})$ | | 0.54 | 0.68 | |
| (i _F = 2.5 Amps, T _J = 125°C) | | 0.40 | _ | |
| (i _F = 5.0 Amps, T _J = 125°C) | | 0.50 | 0.65 | |
| Instantaneous Reverse Current (Note 1) | i _R | | | |
| (Rated dc Voltage, T _J = 25°C) | | _ | 50 | μΑ |
| (Rated dc Voltage, T _J = 125°C) | | 2.2 | 5 | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

^{1.} Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

NRVTS560ETFS, NRVTS560ETFSWF

TYPICAL CHARACTERISTICS

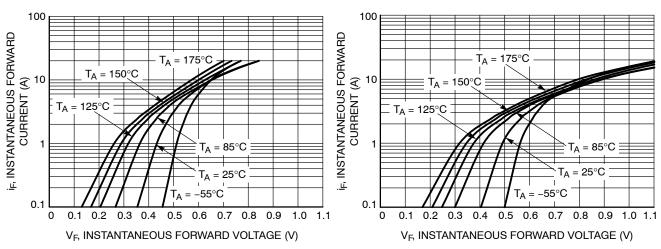


Figure 1. Typical Instantaneous Forward Characteristics

Figure 2. Maximum Instantaneous Forward Characteristics

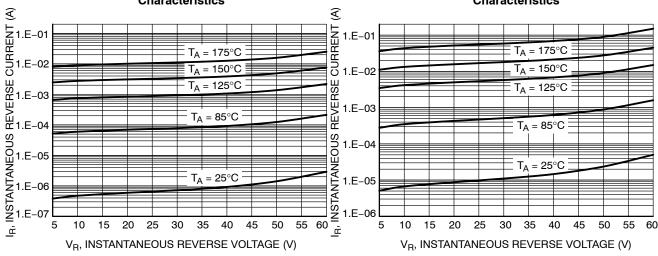


Figure 3. Typical Reverse Characteristics

Figure 4. Maximum Reverse Characteristics

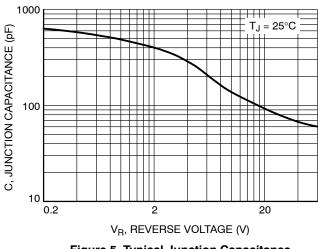


Figure 5. Typical Junction Capacitance

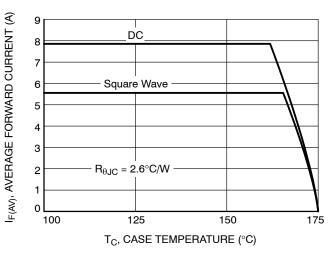
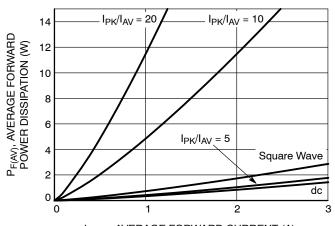


Figure 6. Current Derating per Device

NRVTS560ETFS, NRVTS560ETFSWF

TYPICAL CHARACTERISTICS



 $I_{F(AV)}$, AVERAGE FORWARD CURRENT (A)

Figure 7. Forward Power Dissipation

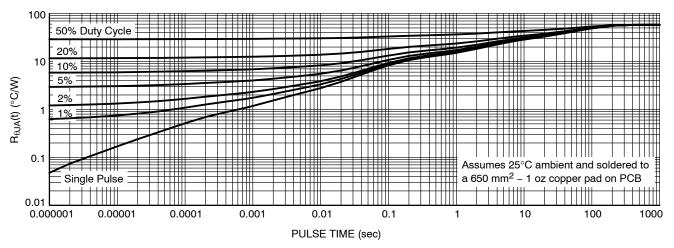


Figure 8. Typical Thermal Response, Junction-to-Ambient

DEVICE ORDERING INFORMATION

| Device | Marking | Package | Shipping [†] |
|-------------------|---------|-------------------|-----------------------|
| NRVTS560ETFSTAG | T560 | μ8FL (Pb–Free) | 1500 / Tape & Reel |
| NRVTS560ETFSWFTAG | T56W | μ8FL (Pb-Free) | 1500 / Tape & Reel |
| NRVTS560ETFSTWG | T560 | μ8FL (Pb-Free) | 5000 / Tape & Reel |
| NRVTS560ETFSWFTWG | T56W | μ8FL (Pb-Free) | 5000 / Tape & Reel |

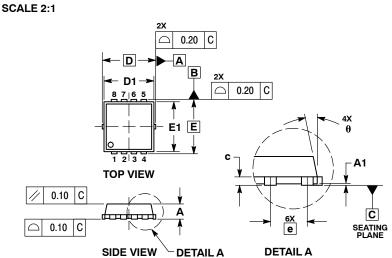
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





WDFN8 3.3x3.3, 0.65P CASE 511AB ISSUE D

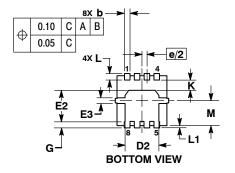
DATE 23 APR 2012



NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH
 PROTRUSIONS OR GATE BURRS.

| | MILLIMETERS | | | | INCHES | | |
|-----|-------------|------|-----------|-----------|--------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.031 | |
| A1 | 0.00 | | 0.05 | 0.000 | | 0.002 | |
| b | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| С | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | 3.30 BSC | | | 0.130 BSC | | | |
| D1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| D2 | 1.98 | 2.11 | 2.24 | 0.078 | 0.083 | 0.088 | |
| E | 3.30 BSC | | 0.130 BSC | | | | |
| E1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| E2 | 1.47 | 1.60 | 1.73 | 0.058 | 0.063 | 0.068 | |
| E3 | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| е | 0.65 BSC | | 0.026 BSC | | | | |
| G | 0.30 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 | |
| K | 0.65 | 0.80 | 0.95 | 0.026 | 0.032 | 0.037 | |
| L | 0.30 | 0.43 | 0.56 | 0.012 | 0.017 | 0.022 | |
| L1 | 0.06 | 0.13 | 0.20 | 0.002 | 0.005 | 0.008 | |
| М | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | |
| θ | 0 ° | | 12 ° | 0 ° | | 12 ° | |

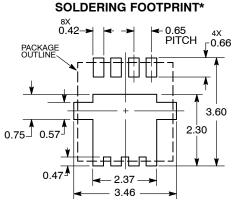


GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code Α = Assembly Location

= Year WW = Work Week = Pb-Free Package



DIMENSION: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|-------------------------|--------------|----------------------|---|-------------|--|
| | DESCRIPTION: | WDFN8 3.3X3.3, 0.65P | | PAGE 1 OF 1 | |

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^{*}This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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